

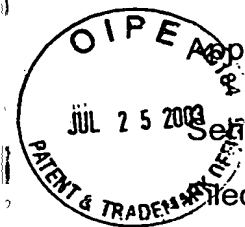


07-28-03

#8 Election/B 2813  
w/Drawings 8/26/03  
Muller

Express Mail No.: EV 335 856 295 US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Application of: Fukutomi et al.

Serial No.: 10/042,408 ✓

Filed: January 8, 2002 ✓

Group Art Unit: 2813

Examiner: Berezny, Nema O.

Attorney Docket No.: 7426-082

For: Fabrication Process of Semiconductor Package and Semiconductor Package

**RESPONSE TO REQUIREMENT FOR RESTRICTION UNDER 37 C.F.R. § 1.142**  
**AND PRELIMINARY AMENDMENT UNDER 37 C.F.R. § 1.115**

Mail Stop Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed on June 26, 2003 in connection with the above-identified patent application and in accordance with the Rules of Practice, please enter the following amendments and consider the following remarks.

Submitted herewith is Appendix A, revised drawing sheets 1, 3 - 7, 9 - 13, 16 - 21, and 23 - 24.

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